

ESD Protection Diodes Silicon Epitaxial Planar

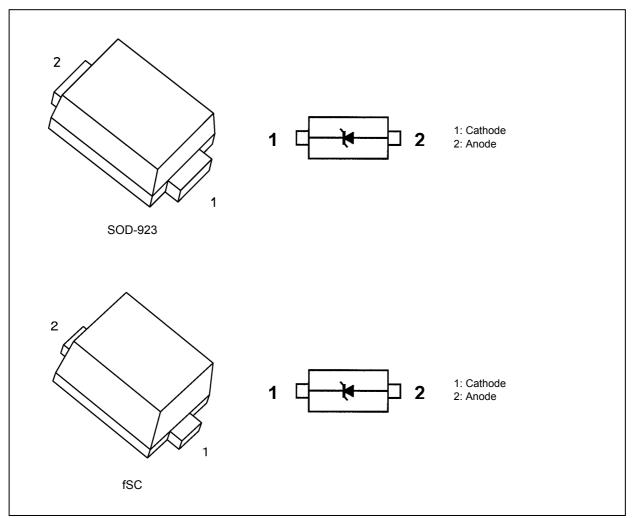
DF2S6.8FS

1. Applications

· ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

2. Packaging and Internal Circuit



The SOD-923 package is recommended.

Package	Product name
SOD-923	DF2S6.8FS,L3M (Note 1)
fSC	DF2S6.8FS,L3J , DF2S6.8FS,L3F

Note 1: The product name of the devices housed in the SOD-923 package are suffixed with the "M".

Start of commercial production



3. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	V _{ESD}	±30	kV
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

4. Electrical Characteristics (Unless otherwise specified, T_a = 25°C)

V_{RWM}: Working peak reverse

voltage

Vz: Zener voltage

V_{BR}: Reverse breakdown voltage

Z_Z: Dynamic impedance

Iz: Zener current

I_{BR}: Reverse breakdown current

I_R: Reverse current V_C: Clamp voltage

I_{PP}: Peak pulse current

R_{DYN}: Dynamic resistance I_F: Forward current

V_F: Forward voltage

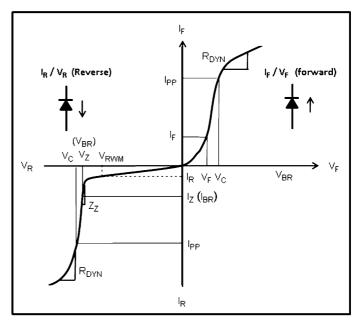


Fig. 4.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Working peak reverse voltage	V_{RWM}		_	_	_	5	V
Zener voltage (Reverse breakdown voltage)	V _Z (V _{BR})		$I_Z = 5 \text{ mA}$ (I_{BR})	6.4	6.8	7.2	\ \
Dynamic impedance	Z _Z		$I_Z = 5 \text{ mA}$ (I_{BR})			30	Ω
Reverse current	I _R		V _{RWM} = 5 V	_	_	0.5	μА
Clamp voltage	V _C	(Note 1)	I _{PP} = 1 A	_	9	_	V
Dynamic resistance	R _{DYN}	(Note 2)	_	_	0.7	_	Ω
Total capacitance	Ct		V _R = 0 V, f = 1 MHz	_	25		pF

Note 1: Based on IEC61000-4-5 8/20 μs pulse.

Note 2: TLP parameter: $Z0 = 50 \Omega$, tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at I_{PP} between 3 A to 8 A.

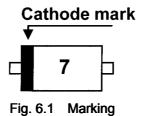


5. Guaranteed ESD Protection (Note)

Test Condition	ESD Protection	
IEC61000-4-2 (Contact discharge)	±30 kV	

Note: Criterion: No damage to devices.

6. Marking



7. Land Pattern Dimensions (for reference only)

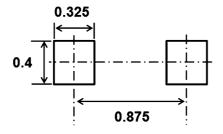


Fig. 7.1 SOD-923 (unit: mm)

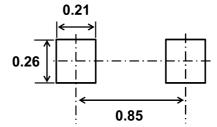
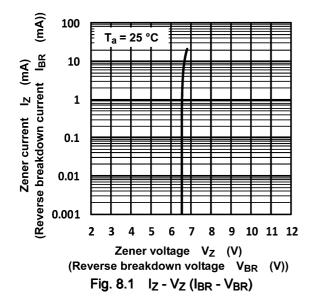


Fig. 7.2 fSC (unit: mm)

8. Characteristics Curves (Note)



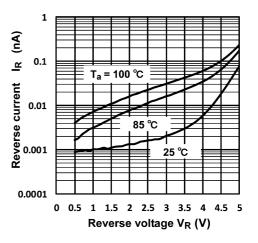
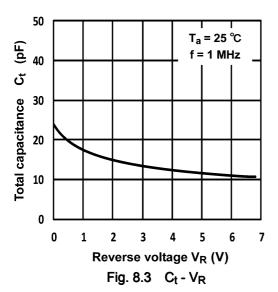
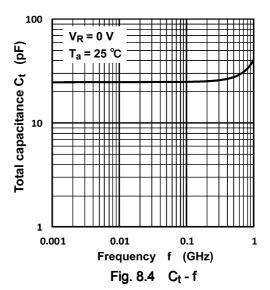


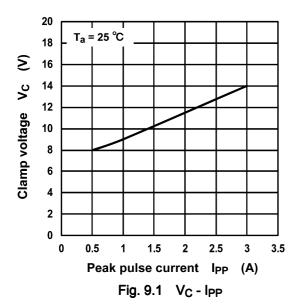
Fig. 8.2 I_R - V_R





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

9. Clamp Voltage V_C - Peak Pulse Current (I_{PP}) (Note)



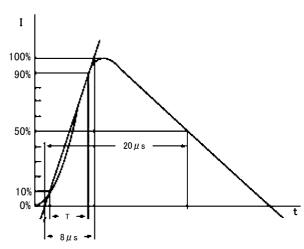
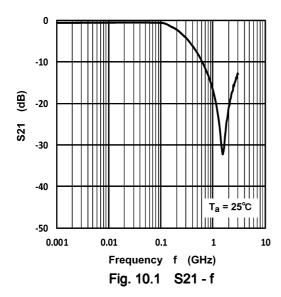
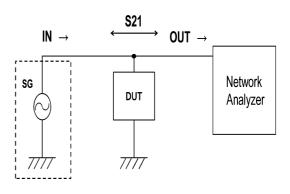


Fig. 9.2 Based on IEC61000-4-5 8/20 μ s pulse.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

10. Insertion Loss (S21) (Note)





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



11. ESD Clamp Waveform (Note)

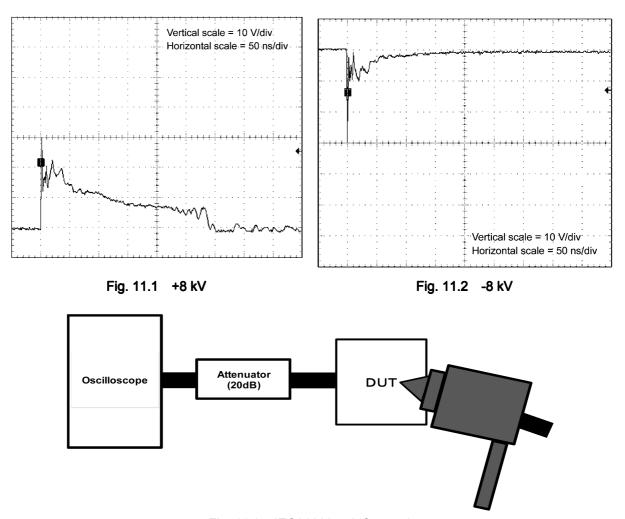


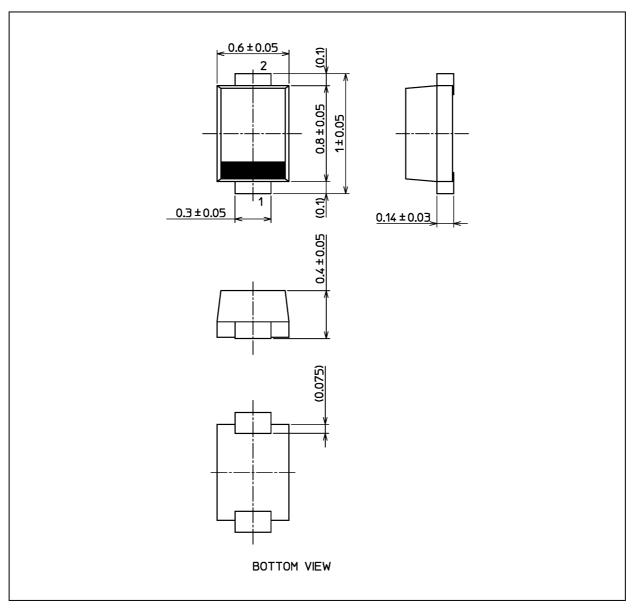
Fig. 11.3 IEC61000-4-2(Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

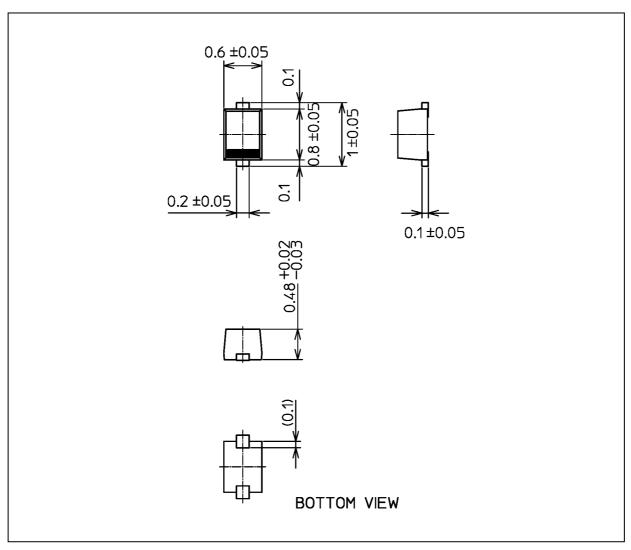
Weight: 0.55 mg (typ.)

Package Na	me(s)
TOSHIBA: 1-1AH1A	
Nickname: SOD-923	



Package Dimensions

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.6 mg (typ.)

F	Package Name(s)
TOSHIBA: 1-1L1S	
Nickname: fSC	



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